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To the Honorable Commissioner of F

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original documents or copy thereof.

1. Name of conveying party(ies):

CHIN KUN LAN, TING CHUN WANG, TONG-HUA  
KUAN AND YING-LANG WANG

2. Name and address of receiving party(ies):

Name: Taiwan Semiconductor Manufacturing  
Company

Internal Address:

Street Address:

121 Park Ave. 3  
Science-Based Industrial Park  
City: Hsin-Chu Zip:  
Country: Taiwan, R.O.C.Additional name(s) or conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance

- ☒ Assignment ☐ Merger
- ☐ Security Agreement ☐ Change of Name
- ☐ other \_\_\_\_\_

Execution Date: 5/25/00Additional name(s) & address(es) attached? Yes ☒ No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 5/25/00A. Patent Application No(s)B. Patent No. (s)Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: GEORGE O. SAILE

Internal Address: \_\_\_\_\_

Street Address: 20 MCINTOSH DRIVECity: POUGHKEEPSIE State: NY ZIP: 126036. Total no. of applications and patents involved: 17. Total fee (37 CFR 3.41): \$ 40.00

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GEORGE O. SAILE

Name of Person Signing

George O. Saile

Signature

July 10 2000

Date

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For ☒ U.S. and/or ☒ Foreign Rights

For ☒ Application or ☐ U.S. Patent

By ☒ Inventor(s) or ☐ Present Owner

### ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

#### ASSIGNOR:

CHIN KUN LAN  
Type or print name of ASSIGNOR

9, Creation Rd. I, Science-  
Address

Based Industrial Park Hsin-chu,  
Taiwan

R.O.C.  
Nationality

TING CHUN WANG  
Type or print name of ASSIGNOR

No. 51, Lane 11, Yi-shin III Sec.  
Address

Yang-Mei town, Tao-Yen Country,

Taiwan R.O.C.  
Nationality

TONG-HUA KUAN  
Type or print name of ASSIGNOR

5F, No. 23-2, Lane 555, Sec. 1,  
Address

Kuang-Fu Road, Hsin-chu, Taiwan

R.O.C.  
Nationality

YING-LANG WANG  
Type or print name of ASSIGNOR

No 37-10, Lung-Po Road, Tien-chung Village,  
Address

Lung-ching Country, Tai-chung County, Taiwan

R.O.C.  
Nationality

#### ASSIGNEE:

**Taiwan Semiconductor Manufacturing Co. Ltd.**

**121 Park Ave. 3**

**Science-Based Industrial Park**

**Hsin-Chu, Taiwan, R.O.C.**

**Taiwan, R.O.C.**

Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

☒ the entire right, title and interest

☐ an undivided \_\_\_\_\_ percent (\_\_\_\_%) interest for the United States and its territorial possessions  
(check the following box/f foreign rights are also to be assigned)

☒ and in all foreign countries

in and to any and all improvements which are disclosed in the invention entitled:

**Planarization Of Shallow Trench Isolation (STI)**

and which is found in

- (a) ☒ U.S. patent application executed on even date herewith  
(b) ☐ U.S. patent application executed on \_\_\_\_\_  
(c) ☐ U.S. application serial no. \_\_\_\_\_ filed on \_\_\_\_\_  
(d) ☐ U.S. patent no. \_\_\_\_\_ issued \_\_\_\_\_  
(e) ☐ and any legal equivalent thereof in a foreign country, including the right to claim priority

(also check (e) if foreign application(s) is also being assigned)

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute, thereof, and as to letters patent any re-issue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I / We have signed this

May 25, 2000 (Date of signing)

**WARNING** Date of signing must be the same as the date of execution of the application if item (a) was checked above.

Chin-Kun Lan  
Signature of ASSIGNOR(S)  
Ting-Chun Wang  
Tong-Hua Kuan  
Ying-Lang Wang

If ASSIGNOR is a legal entity complete the following information

\_\_\_\_\_  
Type or print the name of the above person authorized to sign on behalf of ASSIGNOR

\_\_\_\_\_  
Title

Note: No witnessing, notarization or legalization is necessary, if the assignment is notarized or legalized then it will only be prima facie evidence (35 USC 261). Use next page if notarization is desired.

\_\_\_\_Notarization or Legalization Page Added.